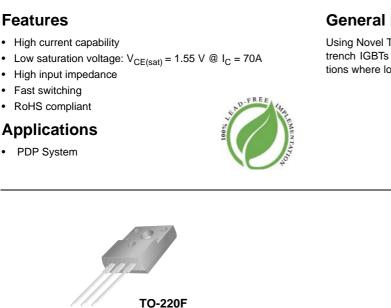
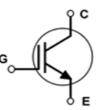
February 2010



GCE (Potted)

# **General Description**

Using Novel Trench IGBT Technology, Fairchild's new series of trench IGBTs offer the optimum performance for PDP applications where low conduction and switching losses are essential.



## **Absolute Maximum Ratings**

FAIRCHILD

SEMICONDUCTOR®

330V PDP IGBT

**FGPF4633** 

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Symbol	Description		Ratings	Units		
V <sub>CES</sub>	Collector to Emitter Voltage		330	V		
V <sub>GES</sub>	Gate to Emitter Voltage		$\pm 30$	V		
I <sub>C pulse(1)*</sub>	Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	300	A		
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	30.5	W		
	Maximum Power Dissipation	@ T <sub>C</sub> = 100 <sup>o</sup> C	12.2	W		
TJ	Operating Junction Temperature		-55 to +150	°C		
T <sub>stg</sub>	Storage Temperature Range		Storage Temperature Range -55 to +		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C		

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	4.1	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	62.5	°C/W

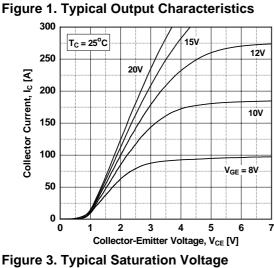
Notes:

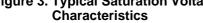
(1) Half Sine Wave, D < 0.01, pluse width < 5µsec

\* Ic\_pluse limited by max Tj

Device N	Device Marking Device I		Package	ackage Packaging Type		Qty per Tube		Max Qty per Box	
FGPF4633 FGPF4633TU T		TO-220F	O-220F Tube		50ea		-		
Electric	al Char	acteristics of the	<b>GBT</b> T <sub>C</sub> = 25	5°C unless otherwise noted	·				
Symbol		Parameter	Test	Conditions	Min.	Тур.	Max.	Units	
Off Charact	teristics								
BV <sub>CES</sub>		o Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA		330	-	-	V	
ΔΒV <sub>CES</sub> ΔΤ <sub>J</sub>		re Coefficient of Breakdown	$V_{GE} = 0V, I_C = 250 \mu A$		-	0.3	-	V/ºC	
I <sub>CES</sub>	-	Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$		-	-	100	μA	
I <sub>GES</sub>	G-E Leaka	age Current	$V_{GE} = V_{GES}$	-	-	-	±400	nA	
On Charact	aristics					1		1	
V <sub>GE(th)</sub>		hold Voltage	I <sub>C</sub> = 250μA, V <sub>CE</sub> = V <sub>GE</sub>		2.4	3.3	4.0	V	
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage		$I_{\rm C} = 20$ A, $V_{\rm GE} = 15$ V		-	1.1	-	V	
			I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V		-	1.35	-		
				I <sub>C</sub> = 70A, V <sub>GE</sub> = 15V,		1.55	1.8	V	
				I <sub>C</sub> = 70A, V <sub>GE</sub> = 15V,		1.61	-	V	
Dynamic C	haracterist	ics							
C <sub>ies</sub>	Input Capacitance			-	1715	-	pF		
C <sub>oes</sub>	Output Ca		V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz		-	75	-	pF	
C <sub>res</sub>	Reverse T	ransfer Capacitance			-	55	-	pF	
Switching (	Characteris	stics			1	I		1	
t <sub>d(on)</sub>	Turn-On D	elay Time			-	8	-	ns	
t <sub>r</sub>	Rise Time		$V_{CC} = 200V_{cc}$		-	30	-	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time	Resistive Lo	$R_G = 5\Omega$ , $V_{GE} = 15V$ Resistive Load, $T_C = 25^{\circ}C$		52	-	ns	
t <sub>f</sub>	Fall Time					260	-	ns	
t <sub>d(on)</sub>	Turn-On D	elay Time			-	8	-	ns	
t <sub>r</sub>	Rise Time		$V_{CC} = 200V_{CC}$		-	32	-	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time		$R_G = 5\Omega$ , $V_{GE} = 15V$ , Resistive Load, $T_C = 125^{\circ}C$		53	-	ns	
t <sub>f</sub>	Fall Time				-	341	-	ns	
Qg	Total Gate	Charge	\/200\/	1 204	-	60	-	nC	
Q <sub>ge</sub>	Gate to Er	nitter Charge	– V <sub>CE</sub> = 200V <sub>,</sub> V <sub>GE</sub> = 15V	IC = 20A	-	8	-	nC	
Q <sub>gc</sub>	Gate to Co	ollector Charge			-	20	-	nC	

# **Typical Performance Characteristics**





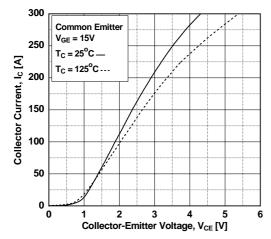


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

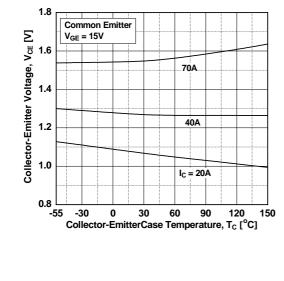
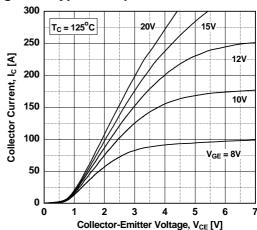
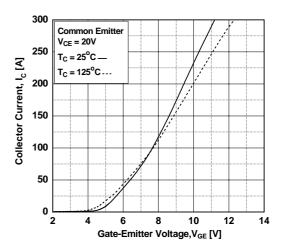
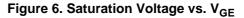


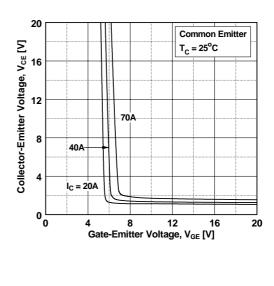
Figure 2. Typical Output Characteristics



**Figure 4. Transfer Characteristics** 







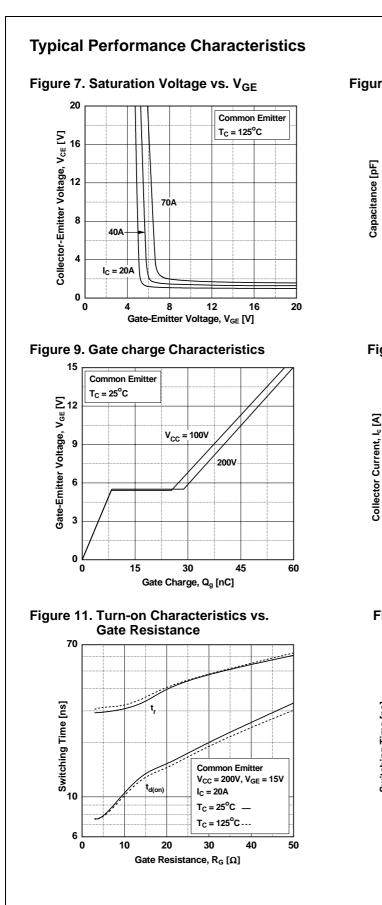


Figure 8. Capacitance Characteristics

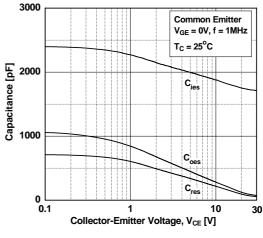


Figure 10. SOA Characteristics

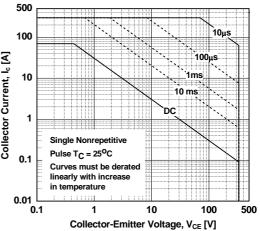
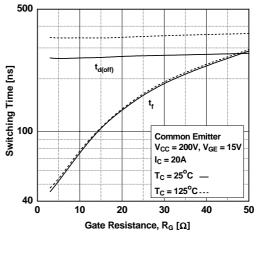
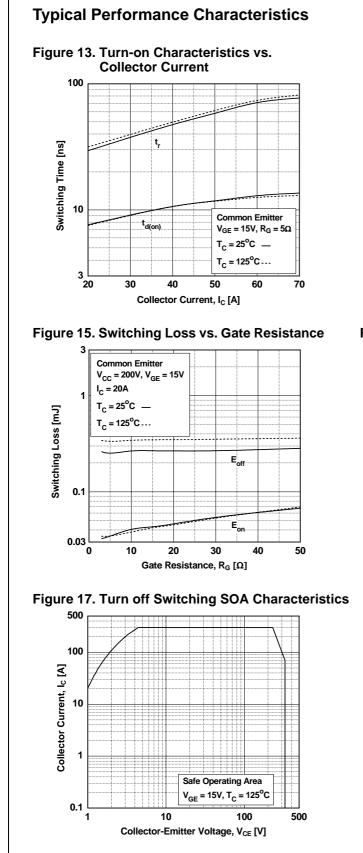
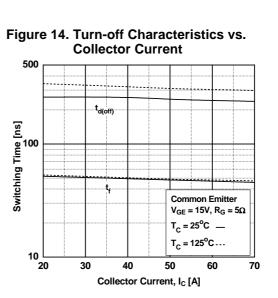


Figure 12. Turn-off Characteristics vs. Gate Resistance

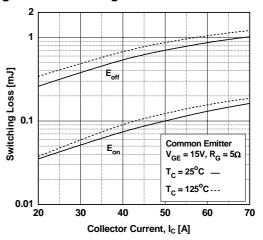


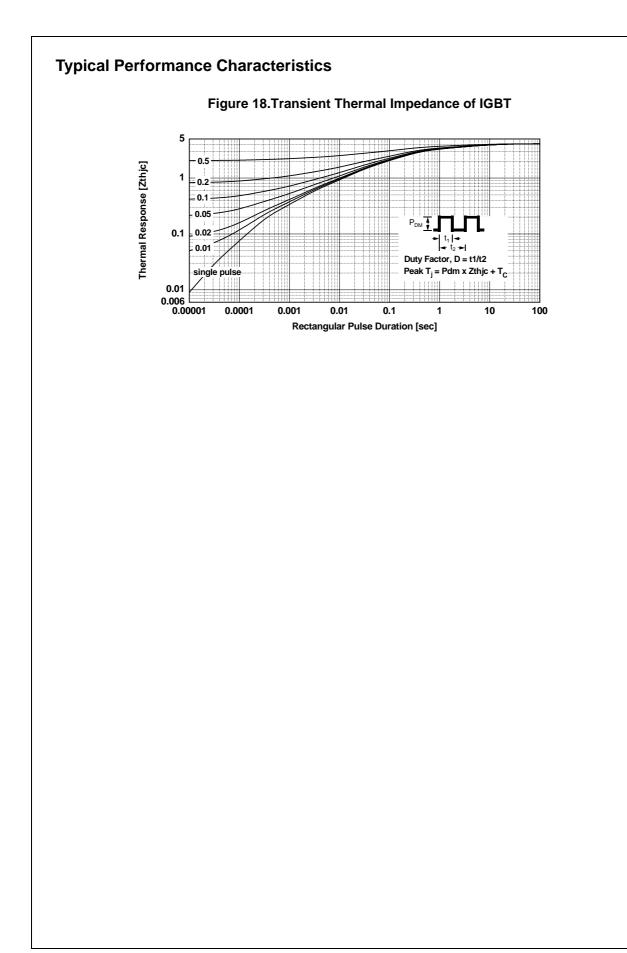
FGPF4633 330V PDP Trench IGBT

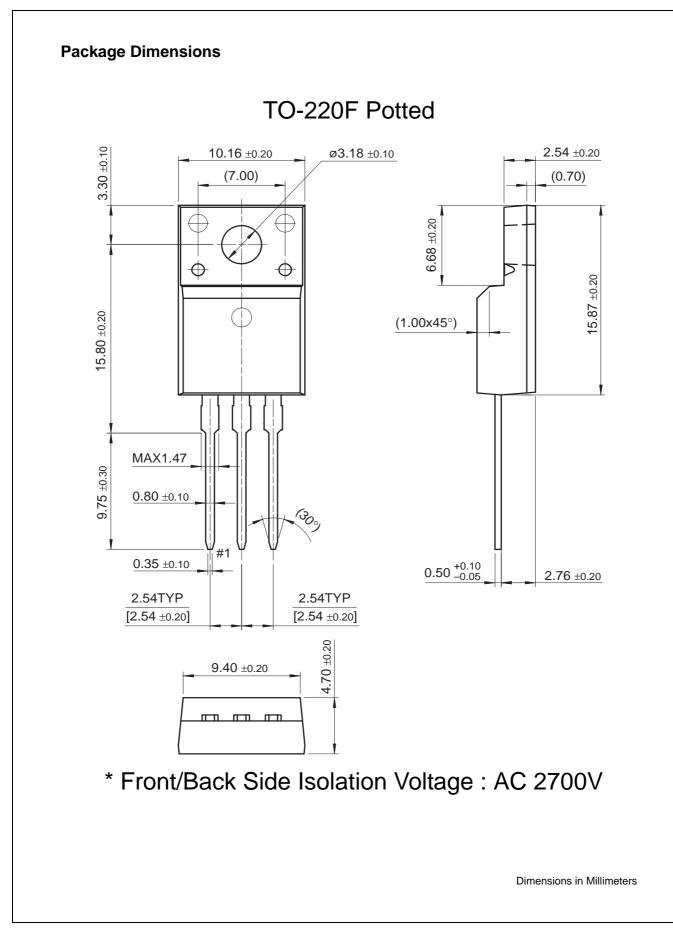












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